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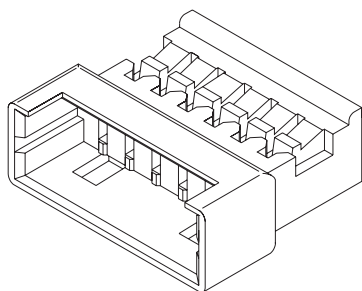
JAMECO[®]
ELECTRONICS

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Jameco Part Number 1932635

1.25mm (.049") Pitch PicoBlade™ Wire-to-Wire Plug 51047



Features and Benefits

- Sizes 2 to 10 circuits

Reference Information

Packaging: Bag
Use With: 50125/50133
Mates With: 51021
Designed In: Millimeters

Electrical

Voltage: 125V
Current: 1.0A (32 AWG—0.8A)
Contact Resistance: 20 milliohms max.
Dielectric Withstanding Voltage: 250V AC/1 min.
Insulation Resistance: 100 Megohms min.

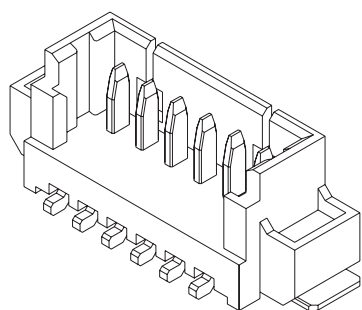
Physical

Housing: PBTP, UL 94V-0
Operating Temperature: -40 to +85°C

Circuits	Order No.
2	51047-0200
3	51047-0300
4	51047-0400
5	51047-0500
6	51047-0600

Circuits	Order No.
7	51047-0700
8	51047-0800
9	51047-0900
10	51047-1000

1.25mm (.049") Pitch PicoBlade™ Wire-to-Board Header 53398 Vertical, SMT



Features and Benefits

- Sizes 2 to 15 circuits
- Locking windows provide secure mating
- Metal solder tabs provide PCB hold-down and strain relief for SMT tails

Reference Information

Packaging: Embossed tape
Mates With: 51021
Designed In: Millimeters

Electrical

Voltage: 125V
Current: 1.0A (32 AWG—0.8A)
Contact Resistance: 20 milliohms max.
Dielectric Withstanding Voltage: 250V AC/1 min.
Insulation Resistance: 100 Megohms min.

Physical

Housing: Glass-filled 4/6 nylon, UL 94V-0
Contact: Phosphor Bronze
Plating: Tin
Solder Tabs: Phosphor Bronze, Tin plating
Operating Temperature: -40 to +85°C

Circuits	Order No.	Carrier Tape Width	Lead-free
2	53398-0271	16.00 (.630)	Yes
3	53398-0371		
4	53398-0471		
5	53398-0571		
6	53398-0671	24.00 (.945)	
7	53398-0771		
8	53398-0871		
9	53398-0971		
10	53398-1071		

Circuits	Order No.	Carrier Tape Width	Lead-free
11	53398-1171	32.00 (1.260)	Yes
12	53398-1271		
13	53398-1371		
14	53398-1471	44.00 (1.732)	
15	53398-1571		



PRODUCT SPECIFICATION



LANGUAGE
JAPANESE
ENGLISH

[3. 定格及び適用電線 RATINGS AND APPLICABLE WIRES]

項 目 Item	規 格 Standard	
最大許容電圧 Rated Voltage (MAX.)	125 V (実効値 rms)	
最大許容電流 及び適用電線 Rated Current (MAX.) and Applicable wires	AWG. #26	1.0 A
	AWG. #28	1.0 A
	AWG. #30	1.0 A
	AWG. #32	0.8 A
使用温度範囲 Ambient Temperature Range	-40℃ ~ +85℃ ^{*1}	

*1: 通電による温度上昇分も含む。
Including terminal temperature rise.

	REVISE ON PC ONLY		TITLE: 1.25mm PITCH WIRE TO BOARD CONNECTOR -LEAD FREE-製品仕様書		
	G	SEE SHEET 1 OF 10			
		THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
		REV.	DESCRIPTION		
DOCUMENT NUMBER PS-51021-024				FILE NAME PS51021024.DOC	SHEET 2 OF 10
EN-37-1(019)					



PRODUCT SPECIFICATION



LANGUAGE

JAPANESE
ENGLISH

[4. 性能 PERFORMANCE]

4-1. 電気的性能 ELECTRICAL PERFORMANCE

項 目 Item		条 件 Test Condition	規 格 Requirement
4-1-1	接触抵抗 Contact Resistance	コネクタを嵌合させ、開放電圧20mV 以下、 短絡電流 10mA以下にて測定する。 (JIS C5402 5.4) Mate connectors, measure by dry circuit, 20mV MAX., 10mA MAX. (JIS C5402 5.4)	20 milliohm MAX.
4-1-2	絶縁抵抗 Insulation Resistance	コネクタを嵌合させ、隣接するターミナル間及び ターミナル、アース間に、DC 500V を印加し測 定する。 (JIS C5402 5.2/MIL-STD-202 試験法 302B) Apply 500V DC between adjacent terminals or terminal and ground. (JIS C5402 5.2/MIL-STD-202 Method 302B)	100 Megohm MIN.
4-1-3	耐電圧 Dielectric Strength	コネクタを嵌合させ、隣接するターミナル間及び ターミナル、アース間に、AC 250V (実効値) を 1分間 印加する。 (JIS C5402 5.1/MIL-STD-202 試験法 301) Apply 250V AC(rms) between adjacent terminals or terminal and ground for 1 minute. (JIS C5402 5.1/MIL-STD-202 Method 301)	異状なきこと No Breakdown
4-1-4	圧着部接触抵抗 Contact Resistance on Crimped Portion	ターミナルに適合電線を圧着し、開放電圧20mV 以下、短絡電流 10mA以下 にて測定する。 Crimp the applicable wire to the terminal, and measure contact resistance by dry circuit, 20mV MAX., 10mA.MAX.	5 milliohm MAX.

REVISE ON PC ONLY

G

SEE SHEET 1 OF 10

TITLE:

1.25mm PITCH WIRE TO BOARD CONNECTOR

-LEAD FREE-

製品仕様書

REV.

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DOCUMENT NUMBER

PS-51021-024

FILE NAME

PS51021024.DOC

SHEET

3 OF 10

EN-37-1(019)



PRODUCT SPECIFICATION



LANGUAGE

JAPANESE
ENGLISH

4-2. 機械的性能 MECHANICAL PERFORMANCE

項 目 Item		条 件 Test Condition	規 格 Requirement	
4-2-1	挿入力 及び抜去力 Insertion and Withdrawal Force	毎分 $25 \pm 3\text{mm}$ の速さで挿入、抜去を行 う。 Insert and withdraw connectors at the speed rate of $25 \pm 3\text{mm/minute}$.	第 7 参照 Refer to paragraph 7	
4-2-2	圧着部 引張り強度 Crimping Strength	圧着されたターミナルを治具に固定し、電 線を軸方向に毎分 $25 \pm 3\text{mm}$ の速さで引張 る。 (JIS C5402 6.8) Fix the crimped terminal, apply axial pull out force on the wire at the speed rate of $25 \pm 3\text{mm/minute}$. (JIS C5402 6.8)	AWG. #26	9.8 N {1.0kgf} MIN.
			AWG. #28	9.8 N {1.0kgf} MIN.
			AWG. #30	4.9 N {0.5kgf} MIN.
			AWG. #32	3.0 N {0.3kgf} MIN.
4-2-3	ターミナル 挿入力 Terminal Insertion Force	圧着されたターミナルをハウジングに 挿入する。 Insert the crimped terminal into the housing.	4.9 N {0.5kgf} MAX.	
4-2-4	ターミナル 保持力 Terminal/ Housing Retention Force	圧着されたターミナルをハウジングに装着 し、 電線を軸方向に毎分 $25 \pm 3\text{mm}$ の速さで 引張る。 Apply axial pull out force to the terminal assembled in the housing at the speed rate of $25 \pm 3\text{mm/minute}$.	4.9 N {0.5kgf} MIN.	
4-2-5	ピン保持力 Pin Retention Force	毎分 $25 \pm 3\text{mm}$ の速さで ピンを軸方 向に 押す。 Apply axial push force at the speed rate of $25 \pm 3\text{mm/minute}$.	4.9 N {0.5kgf} MIN.	

	REVISE ON PC ONLY		TITLE: 1.25mm PITCH WIRE TO BOARD CONNECTOR -LEAD FREE-製品仕様書			
	G	SEE SHEET 1 OF 10				
		THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
		REV.	DESCRIPTION			
DOCUMENT NUMBER PS-51021-024				FILE NAME PS51021024.DOC	SHEET 4 OF 10	
EN-37-1(019)						



PRODUCT SPECIFICATION



LANGUAGE

JAPANESE
ENGLISH

	REVISE ON PC ONLY		TITLE: 1.25mm PITCH WIRE TO BOARD CONNECTOR -LEAD FREE-製品仕様書	
	G	SEE SHEET 1 OF 10		
	REV.	DESCRIPTION	THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	
DOCUMENT NUMBER PS-51021-024				FILE NAME PS51021024.DOC
				SHEET 5 OF 10



PRODUCT SPECIFICATION



LANGUAGE

JAPANESE
ENGLISH

4-3. その他 OTHERS

項 目 Item		条 件 Test Condition	規 格 Requirement	
4-3-1	繰り返し挿抜 Repeated Insertion/ Withdrawal	1分間に10回以下の速さで挿入、抜去を30回繰り返す。 When mated up to 30 cycles repeatedly by the rate of 10 cycles per minute.	接触抵抗 Contact Resistance	40 milliohm MAX.
4-3-2	温度上昇 Temperature Rise	コネクタを嵌合させ、最大許容電流を通電し、コネクタの温度上昇分を測定する。 (UL 498) Carrying rated current load. (UL 498)	温度上昇 Temperature Rise	30°C MAX.
4-3-3	耐振動性 Vibration	DC 1mA 通電状態にて、嵌合軸を含む互いに垂直な3方向に掃引割合10~55~10Hz/分全振幅 1.5mmの振動を各2時間加える。 (JIS C60068-2-6/MIL-STD-202 試験法 201) Amplitude : 1.5mm P-P Sweep time : 10-55-10 Hz in 1 minute Duration : 2 hours in each X.Y.Z. axes (JIS C60068-2-6/MIL-STD-202 Method 201)	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	40 milliohm MAX.
			瞬 断 Discontinuity	1.0 microsecond MAX.
4-3-4	耐衝撃性 Shock	DC 1mA 通電状態にて、嵌合軸を含む互いに垂直な6方向に490m/s ² {50G}、の衝撃を各3回加える。 (JIS C60068-2-27/MIL-STD-202 試験法213) 490m/s ² {50G}, 3 strokes in each X.Y.Z. axes. (JIS C60068-2-27 MIL-STD-202 Method 213)	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	40 milliohm MAX.
			瞬 断 Discontinuity	1.0 microsecond MAX.
4-3-5	耐熱性 Heat Resistance	コネクタを嵌合させ、85±2°Cの雰囲気中に96時間放置後取出し、1~2時間室温に放置する。 (JIS C60068-2-2/MIL-STD-202 試験法108) 85±2°C, 96 hours (JIS C60068-2-2/MIL-STD-202 Method 108)	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	40 milliohm MAX.

REVISE ON PC ONLY

G

SEE SHEET 1 OF 10

TITLE:

1.25mm PITCH WIRE TO BOARD CONNECTOR

-LEAD FREE-

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DESCRIPTION

DOCUMENT NUMBER

PS-51021-024

FILE NAME

PS51021024.DOC

SHEET

6 OF 10

EN-37-1(019)



PRODUCT SPECIFICATION



LANGUAGE

JAPANESE
ENGLISH

項 目 Item		条 件 Test Condition	規 格 Requirement	
4-3-6	耐寒性 Cold Resistance	コネクタを嵌合させ、 $-40\pm 3^{\circ}\text{C}$ の雰囲気中に96時間放置後取出し、1～2時間室温に放置する。 (JIS C60068-2-1) $-40\pm 3^{\circ}\text{C}$, 96 hours (JIS C60068-2-1)	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	40 milliohm MAX.
4-3-7	耐湿性 Humidity	コネクタを嵌合させ、 $60\pm 2^{\circ}\text{C}$ 、相対湿度90～95%の雰囲気中に96時間放置後取出し、1～2時間室温に放置する。 (JIS C60068-2-3/MIL-STD-202試験法103) Temperature : $60\pm 2^{\circ}\text{C}$ Relative Humidity : 90～95% Duration : 96 hours (JIS C60068-2-3/MIL-STD-202 Method 103)	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	40 milliohm MAX.
			耐 電 圧 Dielectric Strength	4-1-3項を 満たすこと Must meet 4-1-3
			絶縁抵抗 Insulation Resistance	10 Megohm MIN.
4-3-8	温度サイクル Temperature Cycling	コネクタを嵌合させ、 -55°C に30分、 $+105^{\circ}\text{C}$ に30分 これを1サイクルとし、5サイクル繰り返す。但し、温度移行時間は5分以内とする。試験後、1～2時間室温に放置する。 (JIS C0025) 5 cycles of : a) -55°C 30 minutes b) $+105^{\circ}\text{C}$ 30 minutes (JIS C0025)	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	40 milliohm MAX.
4-3-9	塩水噴霧 Salt Spray	コネクタを嵌合させ、 $35\pm 2^{\circ}\text{C}$ にて $5\pm 1\%$ 重量比の塩水を 48 ± 4 時間噴霧し、試験後常温で水洗いした後、室温で乾燥させる。 (JIS C60068-2-11/MIL-STD-202 試験法101) 48 ± 4 hours exposure to a salt spray from the $5\pm 1\%$ solution at $35\pm 2^{\circ}\text{C}$. (JIS C60068-2-11/MIL-STD-202 Method 101)	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	40 milliohm MAX.

REVISE ON PC ONLY

G

SEE SHEET 1 OF 10

TITLE:

1.25mm PITCH WIRE TO BOARD CONNECTOR

-LEAD FREE-

製品仕様書

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DESCRIPTION

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DOCUMENT NUMBER

PS-51021-024

FILE NAME

PS51021024.DOC

SHEET

7 OF 10

EN-37-1(019)



PRODUCT SPECIFICATION



LANGUAGE

JAPANESE
ENGLISH

項 目 Item		条 件 Test Condition	規 格 Requirement	
4-3-10	耐亜硫酸ガス SO ₂ Gas	コネクタを嵌合させ、40±2℃にて50±5ppmの亜硫酸ガス中に24時間放置する。 24 hours expose to 50±5ppm . SO ₂ gas at 40±2℃.	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	40 milliohm MAX.
4-3-11	耐アンモニア性 NH ₃ Gas	コネクタを嵌合させ、濃度28%のアンモニア水を入れた容器中に40分間放置する。 (1Lに対して25mLの割合) 40 minutes exposure to NH ₃ gas evaporating from 28% Ammonia solution.	外 観 Appearance	異状なきこと No Damage
			接触抵抗 Contact Resistance	40 milliohm MAX.
4-3-12	半田付け性 Solderability	端子先端より0.5mm迄、及び金具先端を245±3℃の半田に3±0.5秒浸す。 Soldering Time : 3±0.5 sec. Solder Temperature : 245±3℃ 0.5mm from terminal tip and fitting nail tip.	濡れ性 Solder Wetting	浸漬面積の95%以上 95% of immersed area must show no voids, pin holes
4-3-13	半田耐熱性 Resistance To Soldering Heat	(リフロー時) 第6項の条件を2回繰り返す。 <u>When reflowing</u> Repeat paragraph 6, condition two times.	端子ガタ、割れ等 異状なきこと No Damage	
		(手半田) 端子先端より0.5mm迄、及び金具先端を、370～400℃の半田ゴテにて、最大5秒加熱する。 <u>Soldering iron method</u> Soldering time : 5 sec. MAX. Solder temperature : 370～400℃ 0.5mm from terminal tip and fitting nail tip		

() : 参考規格 Reference Standard

{ } : 参考単位 Reference Unit

	REVISE ON PC ONLY		TITLE: 1.25mm PITCH WIRE TO BOARD CONNECTOR -LEAD FREE-製品仕様書		
	G	SEE SHEET 1 OF 10			
			THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
			REV.	DESCRIPTION	
DOCUMENT NUMBER PS-51021-024				FILE NAME PS51021024.DOC	SHEET 8 OF 10
EN-37-1(019)					



PRODUCT SPECIFICATION



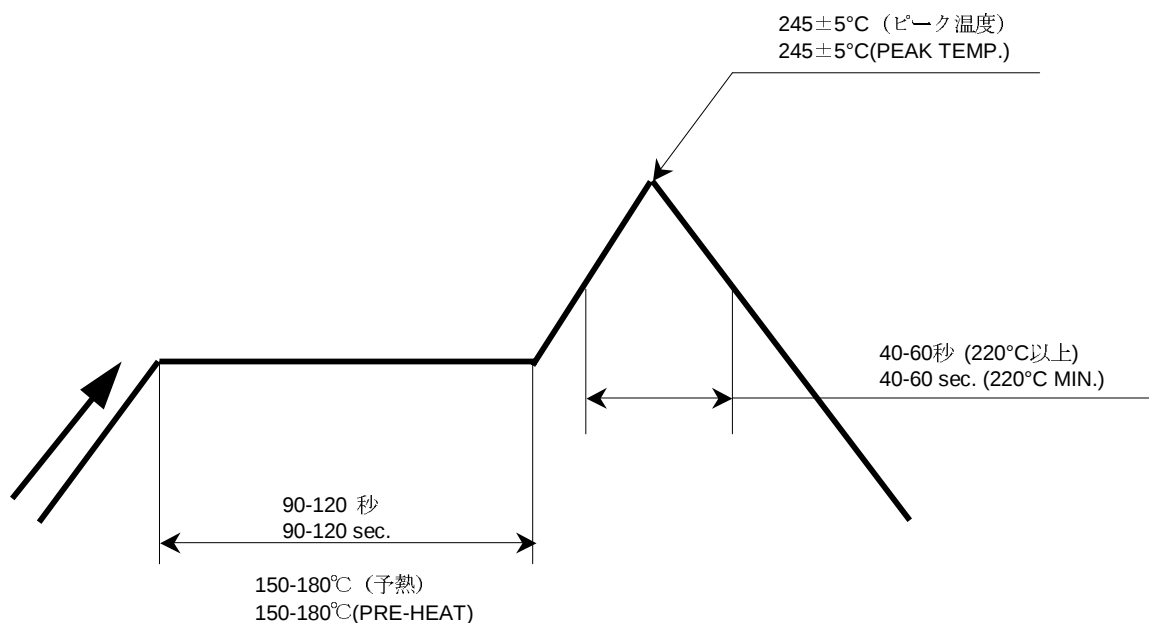
LANGUAGE

JAPANESE
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[5. 外観形状、寸法及び材質 PRODUCT SHAPE, DIMENSIONS AND MATERIALS]

図面参照 Refer to the drawing.

[6. 赤外線リフロー条件 INFRARED REFLOW CONDITION]



温度条件グラフ
(温度は基板パターン面)
TEMPERATURE CONDITION GRAPH
(TEMPERATURE ON THE SURFACE OF P.C.BOARD PATTERN)

注記 ; 本リフロー条件に関しては、リフロー装置及び基板などにより条件が異なりますので、事前にリフロー評価の確認をお願い致します。

また吸湿などの前処理は行わないで下さい。

NOTE ; Please check the reflow soldering condition by your own devices beforehand.
Because the condition changes by the soldering devices, P.C.Boards, and so on.
No moisture treatment before reflow process.

REVISE ON PC ONLY		TITLE:	
G	SEE SHEET 1 OF 10	1.25mm PITCH WIRE TO BOARD CONNECTOR	
		-LEAD FREE- 製品仕様書	
REV.	DESCRIPTION	THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	
DOCUMENT NUMBER PS-51021-024		FILE NAME PS51021024.DOC	SHEET 9 OF 10

EN-37-1(019)



PRODUCT SPECIFICATION



LANGUAGE

JAPANESE
ENGLISH

[7. 挿入力及び抜去力 INSERTION / WITHDRAWAL FORCE]

極数 No. of CKT.	単位 Unit	挿入力 (最大値) Insertion force (MAX.)			抜去力 (最小値) Withdrawal force (MIN.)		
		初回 1st	6回目 6th	30回目 30th	初回 1st	6回目 6th	30回目 30th
2	N { kgf }	19.6 { 2.0 }	17.6 { 1.8 }	15.6 { 1.6 }	2.8 { 0.28 }	2.3 { 0.23 }	1.8 { 0.18 }
3	N { kgf }	24.5 { 2.5 }	22.5 { 2.3 }	20.5 { 2.1 }	3.0 { 0.30 }	2.5 { 0.25 }	2.0 { 0.20 }
4	N { kgf }	29.4 { 3.0 }	27.4 { 2.8 }	25.4 { 2.6 }	3.3 { 0.33 }	2.8 { 0.28 }	2.3 { 0.23 }
5	N { kgf }	34.3 { 3.5 }	32.3 { 3.3 }	30.3 { 3.1 }	3.8 { 0.38 }	3.3 { 0.33 }	2.8 { 0.28 }
6	N { kgf }	39.2 { 4.0 }	37.2 { 3.8 }	35.2 { 3.6 }	4.3 { 0.43 }	3.8 { 0.38 }	3.3 { 0.33 }
7	N { kgf }	44.1 { 4.5 }	42.1 { 4.3 }	40.1 { 4.1 }	4.7 { 0.48 }	4.3 { 0.43 }	3.8 { 0.38 }
8	N { kgf }	49.0 { 5.0 }	47.0 { 4.8 }	45.0 { 4.6 }	5.2 { 0.53 }	4.7 { 0.48 }	4.3 { 0.43 }
9	N { kgf }	53.9 { 5.5 }	51.9 { 5.3 }	49.9 { 5.1 }	5.5 { 0.56 }	5.0 { 0.51 }	4.5 { 0.46 }
10	N { kgf }	58.8 { 6.0 }	56.8 { 5.8 }	54.8 { 5.6 }	5.8 { 0.59 }	5.3 { 0.54 }	4.8 { 0.49 }
11	N { kgf }	63.7 { 6.5 }	61.7 { 6.3 }	59.7 { 6.1 }	6.1 { 0.62 }	5.6 { 0.57 }	5.1 { 0.52 }
12	N { kgf }	68.6 { 7.0 }	66.6 { 6.8 }	64.6 { 6.6 }	6.4 { 0.65 }	5.9 { 0.60 }	5.4 { 0.55 }
13	N { kgf }	73.5 { 7.5 }	71.5 { 7.3 }	69.5 { 7.1 }	6.7 { 0.68 }	6.2 { 0.63 }	5.7 { 0.58 }
14	N { kgf }	78.4 { 8.0 }	76.4 { 7.8 }	74.4 { 7.6 }	7.0 { 0.71 }	6.5 { 0.66 }	6.0 { 0.61 }
15	N { kgf }	83.3 { 8.5 }	81.3 { 8.3 }	79.3 { 8.1 }	7.3 { 0.74 }	6.8 { 0.69 }	6.3 { 0.64 }
17	N { kgf }	93.1 { 9.5 }	91.2 { 9.3 }	89.2 { 9.1 }	7.9 { 0.8 }	7.4 { 0.75 }	6.9 { 0.70 }

REVISE ON PC ONLY

G

SEE SHEET 1 OF 10

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FILE NAME

PS51021024.DOC

SHEET

10 OF 10

EN-37-1(019)



PRODUCT SPECIFICATION



LANGUAGE

JAPANESE
ENGLISH

	REVISE ON PC ONLY		TITLE: 1.25mm PITCH WIRE TO BOARD CONNECTOR -LEAD FREE-製品仕様書	
	G	SEE SHEET 1 OF 10		
	REV.	DESCRIPTION	THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	
DOCUMENT NUMBER PS-51021-024				FILE NAME PS51021024.DOC
				SHEET 11 OF 10
EN-37-1(019)				



PRODUCT SPECIFICATION



LANGUAGE

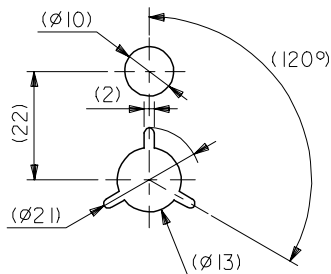
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A	RELEASED	'04/02/05	J2004-2276	E.SUZUKI	K.TOJO
B	REVISED	'04/03/10	J2004-3002	E.SUZUKI	K.TOJO
C	REVISED	'04/03/29	J2004-3401	E.SUZUKI	K.TOJO
D	REVISED	'04/07/21	J2005-0243	N.AIDA	K.TOJO
E	REVISED	'04/12/06	J2005-1671	E.SUZUKI	K.TOJO
F	REVISED	'05/02/15	J2005-2371	E.SUZUKI	K.TOJO
G	REVISED	'05/04/19	J2005-3130	N.AIDA	K.TOYODA

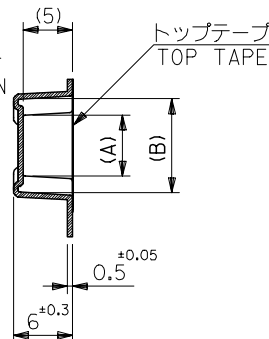
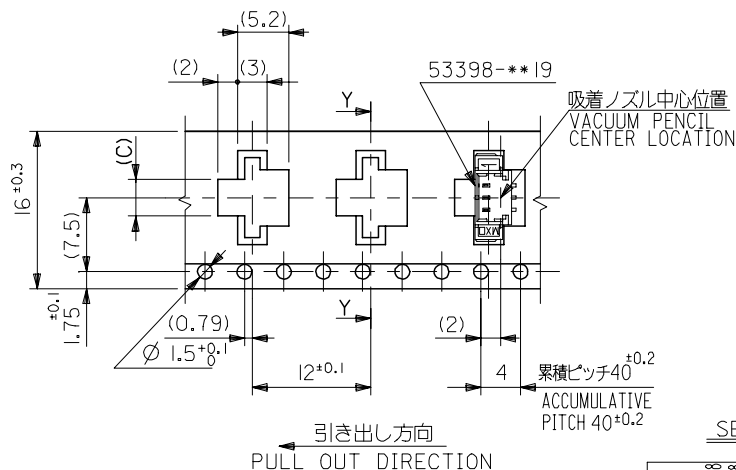
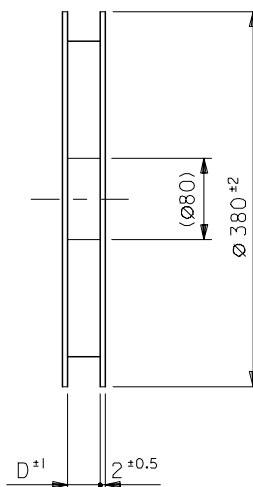
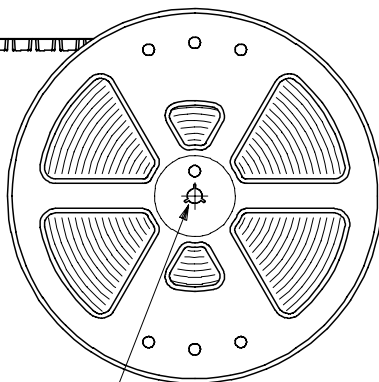
	REVISE ON PC ONLY		TITLE: 1.25mm PITCH WIRE TO BOARD CONNECTOR -LEAD FREE-製品仕様書		
	G	SEE SHEET 1 OF 10			
	REV.	DESCRIPTION	THIS DOCUMENT CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INC. AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
DOCUMENT NUMBER PS-51021-024				FILE NAME PS51021024.DOC	SHEET 12 OF 10
EN-37-1(019)					

10 9 8 7 6 5 4 3 2 1

引き出し方向
PULL OUT
DIRECTION



DETAIL "F"



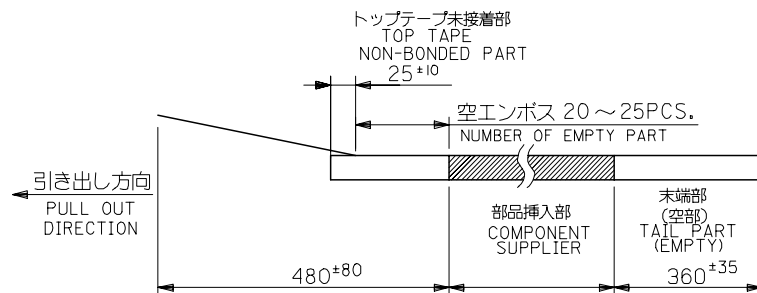
SECT:Y-Y

16幅テープ
(TAPE WIDTH:16)

NOTES

1. 梱包数量: 1000個/リール
NUMBER OF CONNECTOR: 1000PCS/REEL

2. リードテープ長さ
LEAD TAPE LENGTH



3. トップテープの剥離強度: 0.6 ± 0.35N(60 ± 35gf) (剥離方向は下図参照)
PEELING OFF FORCE OF TOP TAPE: 0.6 ± 0.35N(60 ± 35gf)
(PEELING DIRECTION IS SHOWN IN FOLLOWING FIG.)

<剥離速度: 300mm/min (参考)>
PEELING SPEED: 300mm/min.
(REFERENCE)



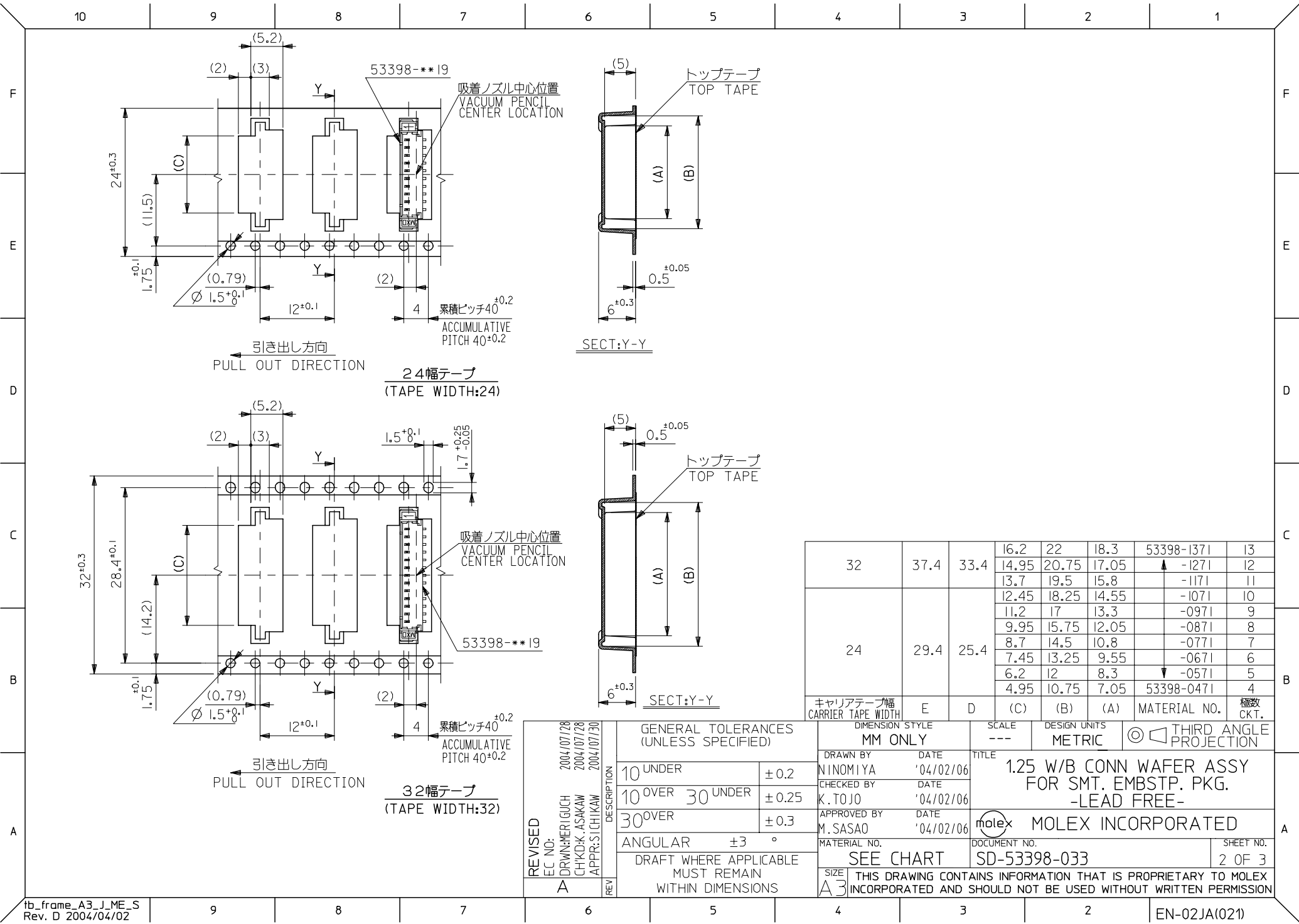
4. 53398-**-19 の詳細寸法については図面 SD-53398-032 を参照下さい。
RE DETAILED DIMENSIONS, SEE SD-53398-032.

5. 材料 (MATERIAL)
キャリアテープ (CARRIER TAPE): ポリプロピレン (POLYPROPYLENE)
トップテープ (TOP TAPE): PET, PE, PEF
リール (REEL): ポリスチレン (P.S) <リサイクル材含む>
POLYSTYREN (P.S) <RECYCLE MATERIAL CONTAINED>

6. 本製品は 53398-**-90 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 53398-**-90.

16	21.4	17.4	3.7	9.5	5.8	53398-0371	3
			2.45	8.25	4.55	53398-0271	2
キャリアテープ幅 CARRIER TAPE WIDTH	E	D	(C)	(B)	(A)	MATERIAL NO.	種数 CKT.

DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
DRAWN BY NINOMIYA	DATE '04/02/06	TITLE 1.25 W/B CONN WAFER ASSY FOR SMT. EMBSTP. PKG. -LEAD FREE-			
CHECKED BY K. TOJO	DATE '04/02/06				
APPROVED BY M. SASAO	DATE '04/02/06	MOLEX INCORPORATED			
MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
SEE CHART		SD-53398-033		1 OF 3	
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					



32	37.4	33.4	16.2	22	18.3	53398-1371	13
			14.95	20.75	17.05	-1271	12
			13.7	19.5	15.8	-1171	11
			12.45	18.25	14.55	-1071	10
			11.2	17	13.3	-0971	9
			9.95	15.75	12.05	-0871	8
			8.7	14.5	10.8	-0771	7
			7.45	13.25	9.55	-0671	6
			6.2	12	8.3	-0571	5
			4.95	10.75	7.05	53398-0471	4
キャリアテープ幅 CARRIER TAPE WIDTH			(C)	(B)	(A)	MATERIAL NO.	種数 CKT.

REVISED
EC NO: 2004/07/28
DRAWN: M.IGUCHI
CHKD: K.ASAKAWA
APPR: S.ICHIKAWA
REV: A

DESCRIPTION
2004/07/28
2004/07/28
2004/07/30

GENERAL TOLERANCES
(UNLESS SPECIFIED)
10 UNDER ±0.2
10 OVER 30 UNDER ±0.25
30 OVER ±0.3
ANGULAR ±3 °
DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM ONLY
DRAWN BY
NINOMIYA
CHECKED BY
K. TOJO
APPROVED BY
M. SASAO
MATERIAL NO.
SEE CHART
SIZE
A3

DATE
'04/02/06
'04/02/06
'04/02/06
'04/02/06
DOCUMENT NO.
SD-53398-033
SHEET NO.
2 OF 3

SCALE

DESIGN UNITS
METRIC

THIRD ANGLE
PROJECTION

TITLE
1.25 W/B CONN WAFER ASSY
FOR SMT. EMBSTP. PKG.
-LEAD FREE-
MOLEX INCORPORATED

